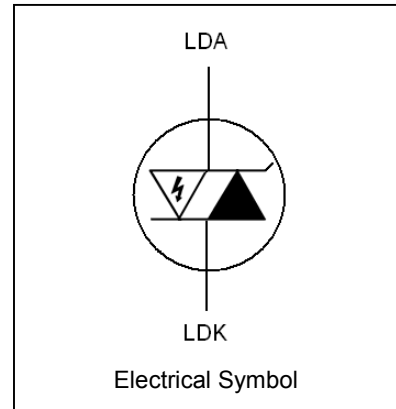


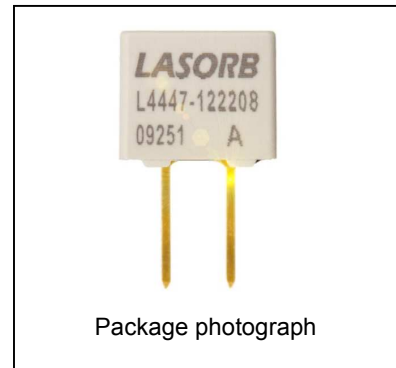
FEATURES

- Compact 2-pin package
- Optimized for red and infrared laser diodes
- Protects against both positive- and negative-ESD, in accordance with ESD standards such as:
 - ANSI/ESD STM5.1
 - MIL-STD 833-c
 - IEC 61340-2-1
 - IEC 61000-4-2
- Protects against reverse bias (reverse polarity)
- Typical capacitance 1200pF ($V_f = 2.2\text{ V}$; $f = 10\text{ MHz}$)
- Lead (Pb)-free component in accordance with RoHS 2002/95/EC and WEEE 2002/96/EC



APPLICATIONS

- Protecting laser diodes from direct and indirect ESD
- Protecting laser diodes from surges during power-up and power-down
- May be used to protect other optoelectronic devices such as Photodiodes and LEDs



GENERAL DESCRIPTION

The L44...228-X series LASORB device is a 2-pin through-hole version of our ESD absorber, designed and tested specifically to protect red and infrared laser diodes and other optoelectronic devices that have an operating voltage between 1.8V and 2.2V. It provides protection against reverse bias as well as fast-changing forward bias conditions.

LASORB is available in the 2-pin through-hole package described here, and is also available in an SMT package having TSOP6 package outline. Custom sizes and packages can also be manufactured.

ORDERING INFORMATION

The part numbers provided below are for the LASORB part optimized for moderate- to high-power red and infrared laser diodes. The main differences are regarding the surge conduction time and voltage-modulation rates. See the application notes for additional information. OEMs are encouraged to work directly with Pangolin to select the best part to maximize overall system performance.

Device part number	Comment
L44-47-122-228-X	Typical surge conduction time = 16 microseconds
L44-47-121-228-X	Typical surge conduction time = 1.6 microseconds

COMMON ELECTRICAL CHARACTERISTICS @ T_J = 25° C

Parameter	Min.	Typ.	Max.	Units	Conditions
Maximum LDA to LDK Voltage ⁽¹⁾			3.2	V	leakage current = 30mA
ESD Event Pulsed Current			50	A	
20 microsecond Pulsed Current			30	A	
Continuous Power Dissipation			2	W	25 °C
Junction and Storage Temperature Range ⁽¹⁾	-55		+150	°C	
LDA to LDK impedance when active			0.033	Ω	
LDA to LDK capacitance		1200		pF	LDA to LDK = 2.2V
Continuous Reverse Bias Current			2.9	A	
Reverse Bias Recovery Time		22	29	nS	I = 8A

L44-47-122-228-X ELECTRICAL CHARACTERISTICS @ T_J = 25° C

Parameter	Min.	Typ.	Max.	Units	Conditions
LDA to LDK leakage current when inactive		0.56	0.6	mA	LDA to LDK = 2.2V ⁽¹⁾
Surge conduction time (see note below)	12	16	20	uS	LDA to LDK = 2.2V pk
Slew-rate during voltage-modulation			65	mV/uS	LDA to LDK = 2.2V p-p
Sinusoidal voltage-modulation rate			10	kHz	LDA to LDK = 2.2V p-p

L44-47-121-228-X ELECTRICAL CHARACTERISTICS @ T_J = 25° C

Parameter	Min.	Typ.	Max.	Units	Conditions
LDA to LDK leakage current when inactive		5.6	6.0	mA	LDA to LDK = 2.2V ⁽¹⁾
Surge conduction time ⁽²⁾	1.2	1.6	2.0	uS	LDA to LDK = 2.2V pk
Slew-rate during voltage-modulation			650	mV/uS	LDA to LDK = 2.2V p-p
Sinusoidal voltage-modulation rate			100	kHz	LDA to LDK = 2.2V p-p

NOTES

1. Operating voltages are specified at 25° C. As the temperature increases, the maximum operating voltage must be de-rated, otherwise leakage current will increase. See the datasheet section about operating at elevated temperatures.
2. "Surge conduction time" defines the amount of time that LASORB will conduct current (diverting it from the laser diode) in response to a fast-transient, large-signal voltage condition across its terminals. The test starts with the LDA and LDK terminals at the same voltage potential (no voltage difference) and then surges current into LDA with respect to LDK, while monitoring at the terminal voltage and observing time to reach the nominal operating voltage.

GENERAL APPLICATION INFORMATION

LASORB is a patented hybrid component that is specifically designed and tested to protect laser diodes from ESD and power surges. LASORB overcomes the problems of previously-known ESD protection schemes by preventing reverse-bias of the laser diode under all conditions, and also by preventing ESD or other power-related faults from exceeding the maximum forward-bias voltage of the laser diode. LASORB is able to do this while not adding significant resistance or capacitance to the laser system.

CONNECTING LASORB TO THE LASER DIODE

LASORB is connected directly to the terminals of a laser diode. The LDA terminal is connected to the Laser Diode Anode, and the LDK terminal is connected directly to the Laser Diode Cathode. LASORB should be connected as closely as possible to the laser diode – certainly no greater than one centimeter away, thus preventing stray inductance in between the laser diode and the ESD protection means.

NEGATIVE-ESD AND REVERSE-BIAS PROTECTION

LASORB includes a fast-acting diode – the cathode of which is connected to the LDA terminal. The fast-acting diode within LASORB has been proven to be generally more robust than a Schottky diode, which is typically used in an attempt to protect a laser diode. The fast-acting diode within LASORB is able to protect a laser diode against ESD whose polarity would tend to reverse bias the laser diode, and also protect the laser diode against pulsed or continuous reverse bias (also known as reverse polarity) conditions. Normally reverse bias only occurs during an ESD event, or when the power supply is turned off. As long as the reverse bias condition does not exceed 2.9 amps RMS or 50 amps peak, no additional reverse bias protection will be needed.

POSITIVE-ESD AND POWER SURGE PROTECTION

LASORB also includes a slew-rate detector, which monitors the voltage between the LDA and LDK terminals. If the slew-rate is faster than a limit that is predetermined for each specific LASORB part number, LASORB will conduct current between the LDA and LDK terminals, thus conducting current away from the laser diode. Using the slew-rate detector, LASORB is able to discern between normal laser diode operation, and a power surge or ESD event. LASORB also includes other circuitry to enhance its ability to discern between normal drive conditions and ESD and, because of this additional circuitry, LASORB is able to protect the laser diode whether power is applied or not.

LEAKAGE CURRENT WHILE INACTIVE

The LASORB device has several degrees of freedom that Pangolin can optimize for a particular type of laser diode and application. One of the degrees of freedom is the leakage current apparent when LASORB is inactive (not responding to an ESD event). Generally speaking, higher levels of leakage current will allow LASORB to better-protect the laser diode while it is lasing. When operated well below the “Maximum LDA to LDK Voltage” found on Page 2 of this datasheet, the leakage current is not temperature dependent and it appears almost purely resistive. However, when operated within around 1 volt of the “Maximum LDA to LDK Voltage”, the leakage current increases as temperature increases. (See the datasheet section on operating at elevated temperatures below.) If desired, Pangolin can minimize this leakage current to levels so low, that it appears like a 5 Gig-ohm resistor (1 nA leakage at 5 volts). In such cases, the ESD protection offered by LASORB is reduced while the laser is lasing. Nevertheless, ESD protection is still present and very impressive, even though it is reduced when compared to LASORB models with higher levels of leakage current.

OPERATION AT ELEVATED TEMPERATURES

There specifications found on Page 2 of this datasheet are made at a junction temperature of 25° C. As the junction temperature increases, the “Maximum LDA to LDK Voltage” must be de-rated, otherwise higher “LDA to LDK leakage current when inactive” will be experienced. For example, at 25° C the L44-47-122-228-X can comfortably be operated at voltages up to 2.7V, and the Maximum LDA to LDK Voltage is 3.2V. At 100C the L44-47-122-228-X should not be operated at voltages much above 2V, and the Maximum LDA to LDK Voltage becomes 2.5V. Please contact Pangolin if LASORB will be operated at temperatures well above 25° C, to make sure that the proper LASORB part is designed in.

MODULATION CONDITIONS AND PART NUMBER RECOMMENDATIONS

Within this datasheet, we use to the term “current-modulation” to indicate those drivers that maintain a continuous voltage bias across the laser diode, and only change this voltage slightly during modulation. We use the term “voltage-modulation” to indicate those drivers that completely remove and re-apply the nominal terminal voltage across the laser diode during modulation.

In typical laser diode drivers (ones which use current-modulation), the voltage across the laser diode terminals typically changes very little even during modulation. However, some laser diode drivers (ones which use voltage-modulation) effectively remove, and then re-apply the nominal terminal voltage (typically 2.2 to 5.0 V) across the laser diode over and over again. This 100% voltage-modulation may fool LASORB into believing that there is a power surge condition, and when this happens, LASORB will conduct current for a brief time, potentially interfering with modulation. To avoid this, you should choose a specific LASORB part number that corresponds with the maximum expected voltage-modulation rate. However, if the laser diode driver does not perform 100% voltage-modulation, then practically any LASORB part will work, and the modulation rate will be primarily dictated by LASORB device capacitance. Since the dynamic impedance of a typical low power red laser diode is well under 5 ohms, the maximum modulation rate is greater than 25 MHz when using current-modulation techniques. For higher power red laser diodes whose dynamic impedance is less than 1 ohm, modulation rates well beyond 100 MHz are possible. For best results and part number recommendations, it is recommended that OEMs contact Pangolin for applications advice and laser diode driver review.

INFORMATION ABOUT ESD STANDARDS AND TESTING

There are several relevant standards for ESD testing and compliance. Each standard has an associated human body model. For example, the IEC 61000-4-2 standard uses a 150pF capacitor in series with a 330-ohm resistor to represent the human body model. The newer ANSI/ESD STM5.1 and IEC 61340-3-1 standards use a 100pF capacitor in series with a 1500-ohm resistor. Normally the ANSI/ESD STM5.1 and IEC 61340-3-1 are standards used to test the ESD performance of electrical components, while the IEC 61000-4-2 standard is used to test the performance of an entire consumer end-product.

At Pangolin, we have tested the ability for LASORB to protect a laser diode when subjected to direct discharges of ESD, using the standards mentioned above. Semiconductor companies generally agree that the IEC 61000-4-2 standard is not realistic for components themselves, which is why the newer ANSI/ESD STM5.1 and IEC 61340-3-1 were developed for testing components. Moreover, it could be argued that subjecting a laser diode to direct discharges of ESD is also not a realistic scenario, since ESD normally only comes in contact with an end-product, and not necessarily the laser diode itself. Nevertheless, at Pangolin our testing of LASORB is very rigorous, and generally exceeds the requirements of the standards as well as realistic discharge scenarios.

In our testing we have found LASORB to be 100% effective at protecting red and infrared laser diodes from positive-ESD events up to 15kV, when using the human body model associated with ANSI/ESD STM5.1 and IEC 61340-3-1. We have also found that LASORB is able to protect all laser diodes from negative-ESD up to 15kV when using the human body model associated with ANSI/ESD STM5.1 and IEC 61340-3-1 as well as IEC 61000-4-2.

Of course in order to achieve a high level of ESD protection, it is required to place the LASORB as closely as possible to the laser diode. In our testing we have connected the LASORB pins directly to the laser diode pins, and the total (round trip) lead length did not exceed 1 centimeter.

SMALL-SIGNAL SPICE MODELS

The behavior of LASORB depends on whether it is operated in the small-signal regime or the large-signal regime. Typically the large-signal regime is only experienced during an ESD event or power surge and laser diode drivers will operate with LASORB in the small-signal regime. Since the large-signal circuit model is quite complex, and since the large-signal regime is experienced only rarely, we only present a simplified small-signal SPICE model within this datasheet.

Note that LASORB has a complex impedance. At very low frequencies, LASORB will appear purely resistive. At frequencies around 10MHz and higher, LASORB will appear as a 1200pF capacitance.

```
*  Spice Subcircuit small-signal model of LASORB L44-47-122-228-X
*
.SUBCKT LASORB 2 1
```

```
R1 2 3 1200
R2 3 1 2700
C1 2 3 1.6N
C2 3 1 4.7N
```

```
.ENDS LASORB
```

```
*  Spice Subcircuit small-signal model of LASORB L44-47-121-228-X
*
.SUBCKT LASORB 2 1
```

```
R1 2 3 120
R2 3 1 270
C1 2 3 1.6N
C2 3 1 4.7N
```

```
.ENDS LASORB
```

OTHER LASORB PART NUMBER FORMULATIONS

As mentioned above, the LASORB device has several degrees of freedom that can be optimized for particular laser diodes and applications. The degrees of freedom allow us to adjust the maximum and typical operating voltage of the laser diode, as well as modulation rate, surge-conduction time, device capacitance and inactive leakage current.

In addition to the parts described in this document, we also offer the following part number formulations as standard off-the-shelf parts:

TSOP6/4G-20V – our SMT part whose operating parameters are user-customizable
L44-47-122-208-X – optimized for very low power, single-mode red, and some IR laser diodes
L44-47-121-392-X – optimized for high power red laser diodes
L44-47-121-683-X – optimized for moderate-to-high power blue laser diodes
L44-47-122-833-X – optimized for low power BLU-RAY and blue-violet laser diodes (100mW or lower)
L44-47-121-833-X – optimized for moderate-to-high power BLU-RAY and blue-violet laser diodes
L44-47-121-916-X – optimized for direct diode green laser diodes
L44-47-121-2000-X – optimized for quantum cascade laser diodes, and series strings of other diodes

CUSTOM SIZES AND PACKAGES

The LASORB device described in this datasheet is packaged in a 2-pin, through-hole package. However, an SMT version is available, and Pangolin has also designed custom packages for specific OEMs. If the standard LASORB package shown here is not convenient and if you have a moderate- to high-volume requirement, Pangolin can make a custom LASORB part as a special shape component or board-mounted configuration. Please contact Pangolin if you are interested in this.

MORE INFORMATION

More information about LASORB, including additional application hints and tips can be found on the LASORB web site at www.lasorb.com.

In addition, OEMs are strongly encouraged to work with Pangolin to make sure that the most appropriate LASORB part number is chosen and designed-in.

PATENT AND TRADEMARK INFORMATION

Australia Patent Number: 2009268619
Chinese Patent Number: ZL200980126761.9
German Patent (Utility Model) Number: 20 2009 013 825.9
United States Patent Number: 8,902,557
International Patent Application Number: PCT/US2009/049999

LASORB is a trademark of Pangolin Laser Systems, Inc.

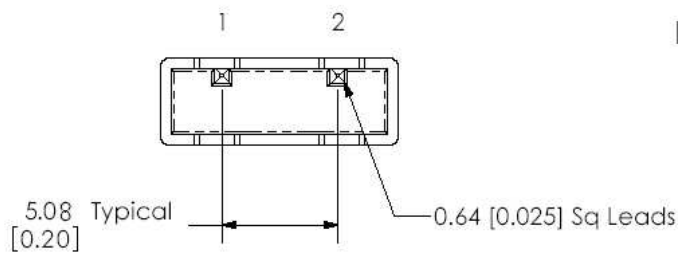
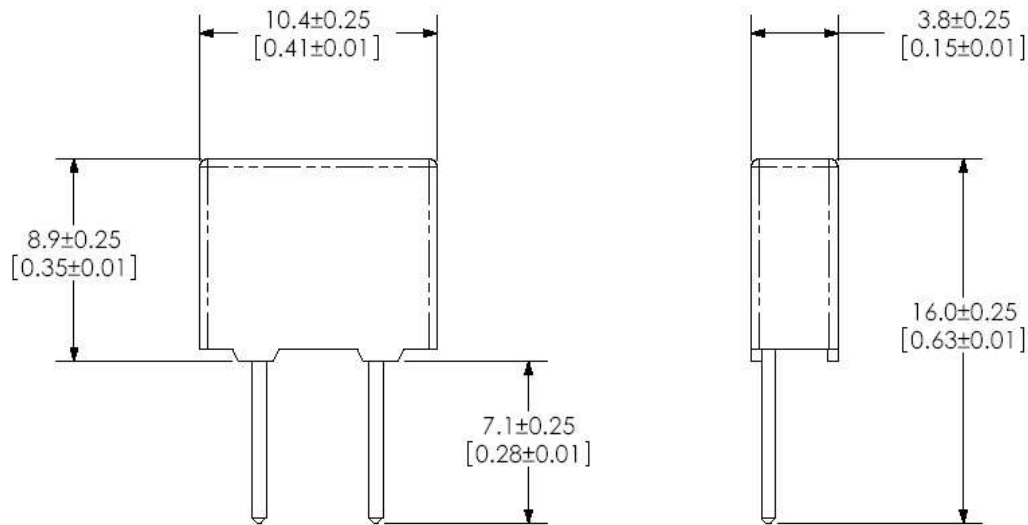
U.S. Headquarters:

Pangolin Laser Systems, Inc.
9501 Satellite Boulevard, Suite 109
Orlando, FL 32837 – USA
Phone: +1-407-299-2088
Fax: +1-407-299-6066

Central Europe Branch Office:

Pangolin d.o.o.
Podutiška cesta 75
1000 Ljubljana, SLOVENIA
Phone: +386-1-517-4270
Fax: +386-1-517-4275

LASORB PACKAGE OUTLINE



Lead Assignments

1 - LDK

2 - LDA

Notes:

1. Dimensions include Mold Flash
2. Controlling Dimensions are in Inches
3. Dimensions are shown in mm [inch]

Pins are flash gold plated over nickel, with no exact plating thickness specification.

For applications requiring a smaller package or different soldering requirements, consider our SMT LASORB component, available in TSOP6 package.

More information can be found at <http://www.lasorb.com/lasorb-datasheets/>

LEGAL DISCLAIMER NOTICE

ALL PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE.

PANGOLIN LASER SYSTEMS, INC., ITS AFFILIATES, AGENTS, AND EMPLOYEES, AND ALL PERSONS ACTING ON ITS OR THEIR BEHALF (COLLECTIVELY, "PANGOLIN"), DISCLAIM ANY AND ALL LIABILITY FOR ANY ERRORS, INACCURACIES OR INCOMPLETENESS CONTAINED HEREIN OR IN ANY OTHER DISCLOSURE RELATING TO ANY PRODUCT.

PANGOLIN DISCLAIMS ANY AND ALL LIABILITY ARISING OUT OF THE USE OR APPLICATION OF ANY PRODUCT DESCRIBED HEREIN OR OF ANY INFORMATION PROVIDED HEREIN TO THE MAXIMUM EXTENT PERMITTED BY LAW. THE PRODUCT SPECIFICATIONS DO NOT EXPAND OR OTHERWISE MODIFY PANGOLIN'S TERMS AND CONDITIONS OF PURCHASE, INCLUDING BUT NOT LIMITED TO THE WARRANTY EXPRESSED THEREIN, WHICH APPLY TO THESE PRODUCTS.

NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT OR BY ANY CONDUCT OF PANGOLIN.

THE PRODUCTS SHOWN HEREIN ARE NOT DESIGNED FOR USE IN MEDICAL, LIFE-SAVING, OR LIFE-SUSTAINING APPLICATIONS UNLESS OTHERWISE EXPRESSLY INDICATED. CUSTOMERS USING OR SELLING PANGOLIN PRODUCTS NOT EXPRESSLY INDICATED FOR USE IN SUCH APPLICATIONS DO SO ENTIRELY AT THEIR OWN RISK AND AGREE TO FULLY INDEMNIFY PANGOLIN FOR ANY DAMAGES ARISING OR RESULTING FROM SUCH USE OR SALE. PLEASE CONTACT AUTHORIZED PANGOLIN PERSONNEL TO OBTAIN WRITTEN TERMS AND CONDITIONS REGARDING PRODUCTS DESIGNED FOR SUCH APPLICATIONS.

PRODUCT NAMES AND MARKINGS NOTED HEREIN MAY BE TRADEMARKS OF THEIR RESPECTIVE OWNERS.